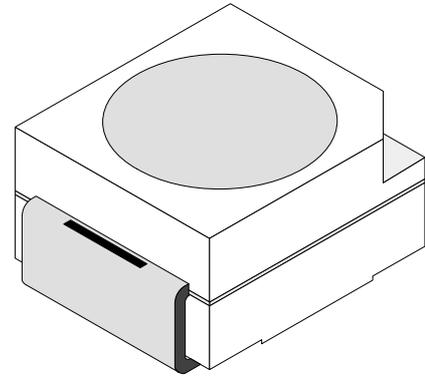


Silicon NPN Phototransistor

Description

TEMT370. series are high speed silicon NPN epitaxial planar phototransistors in a miniature PL-CC-2 package for surface mounting on printed boards. Due to their waterclear epoxy the devices are sensitive to visible and near infrared radiation.



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Features

- PL-CC-2 SMD package
- Extra wide viewing angle $\varphi = \pm 60^\circ$
- Package notch = collector
- Base terminal not connected
- Fast response times
- Suitable for visible and near infrared radiation
- Matches with TSMS 3700 IR emitter

Applications

Miniature switches
Counters and sorters
Interrupters
Tape and card readers
Encoders
Position sensors

Absolute Maximum Ratings

$T_{amb} = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Value	Unit
Collector Emitter Voltage		V_{CEO}	70	V
Emitter Collector Voltage		V_{ECO}	5	V
Collector Current		I_C	50	mA
Peak Collector Current	$t_p/T \leq 0.1, t_p \leq 10\mu\text{s}$	I_{CM}	100	mA
Total Power Dissipation	$T_{amb} \leq 55^\circ\text{C}$	P_{tot}	100	mW
Junction Temperature		T_j	100	$^\circ\text{C}$
Storage Temperature Range		T_{stg}	-55...+100	$^\circ\text{C}$
Soldering Temperature	$t \leq 3\text{ s}$	T_{sd}	260	$^\circ\text{C}$
Thermal Resistance Junction/Ambient		R_{thJA}	450	K/W

Basic Characteristics

$T_{amb} = 25^{\circ}\text{C}$

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Collector Emitter Breakdown Voltage	$I_C = 1\text{ mA}$	$V_{(BR)CEO}$	70			V
Collector Dark Current	$V_{CE} = 20\text{ V}, E = 0$	I_{CEO}		1	200	nA
Collector Emitter Capacitance	$V_{CE} = 5\text{ V}, f = 1\text{ MHz}, E=0$	C_{CEO}		3		pF
Angle of Half Sensitivity		ϕ		± 60		deg
Wavelength of Peak Sensitivity		λ_p		830		nm
Range of Spectral Bandwidth		$\lambda_{0.5}$		620...980		nm
Collector Emitter Saturation Voltage	$E_e=1\text{mW/cm}^2, \lambda=950\text{nm}, I_C=0.1\text{mA}$	V_{CEsat}		0.15	0.3	V
Rise Time / Fall Time	$V_S=5\text{V}, I_C=1\text{mA}, \lambda=950\text{nm}, R_L=1\text{k}\Omega$	t_r / t_f		6		μs
	$V_S=5\text{V}, I_C=1\text{mA}, \lambda=950\text{nm}, R_L=100\Omega$	t_r / t_f		2		μs
Cut-Off Frequency	$V_S=5\text{V}, I_C=2\text{mA}, R_L=100\Omega$	f_c		180		kHz

Type Dedicated Characteristics

$T_{amb} = 25^{\circ}\text{C}$

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Collector Light Current	$E_e=1\text{mW/cm}^2, \lambda=950\text{nm}, V_{CE}=5\text{V}$	TEMT3700	I_{ca}	0.25			mA
		TEMT3703	I_{ca}	0.25	0.4	0.5	mA
		TEMT3704	I_{ca}	0.4	0.6	0.8	mA
		TEMT3705	I_{ca}	0.6			mA

Typical Characteristics ($T_{amb} = 25^{\circ}\text{C}$ unless otherwise specified)

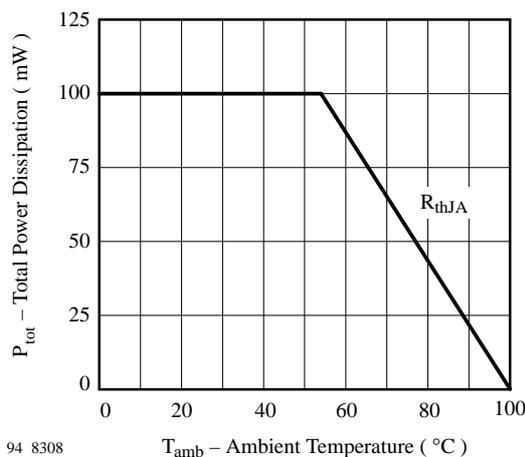


Figure 1. Total Power Dissipation vs. Ambient Temperature

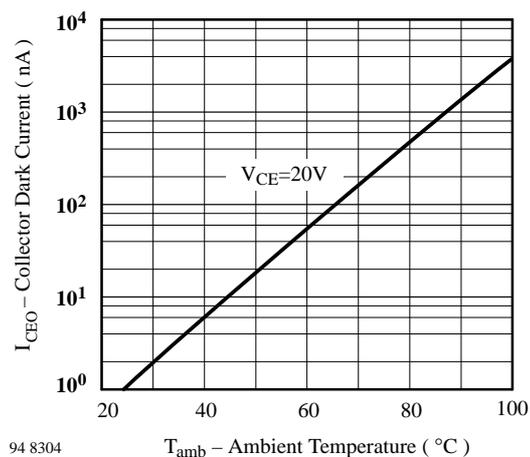


Figure 2. Collector Dark Current vs. Ambient Temperature

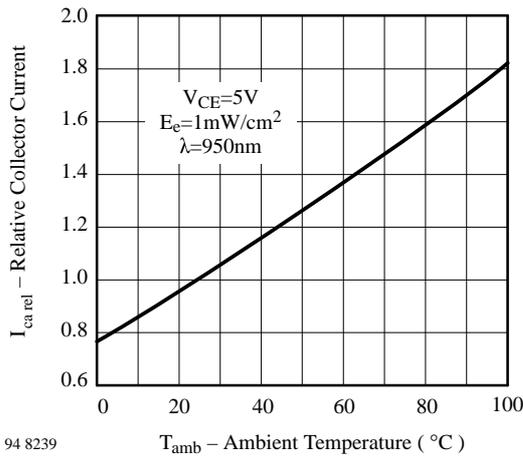


Figure 3. Relative Collector Current vs. Ambient Temperature

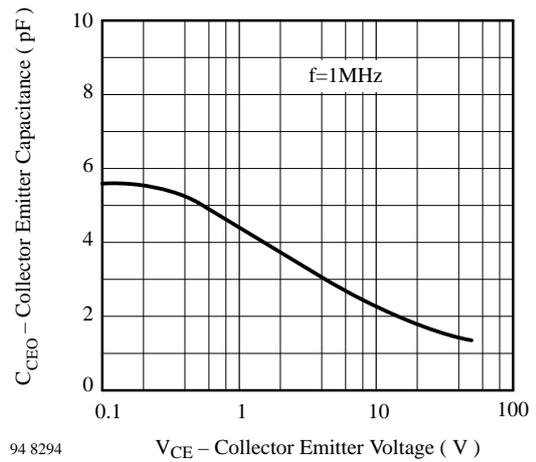


Figure 6. Collector Emitter Capacitance vs. Collector Emitter Voltage

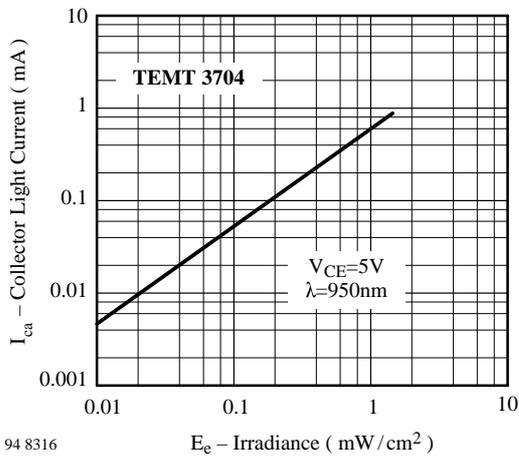


Figure 4. Collector Light Current vs. Irradiance

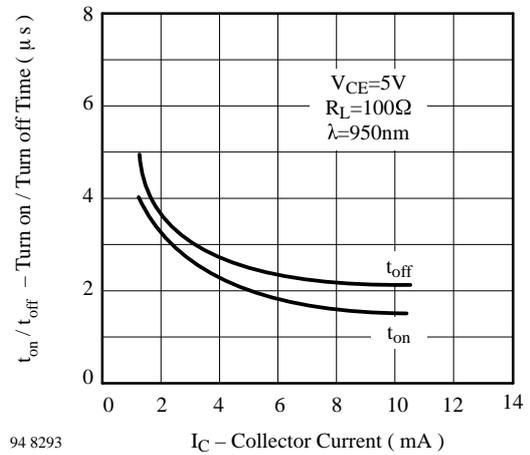


Figure 7. Turn On/Turn Off Time vs. Collector Current

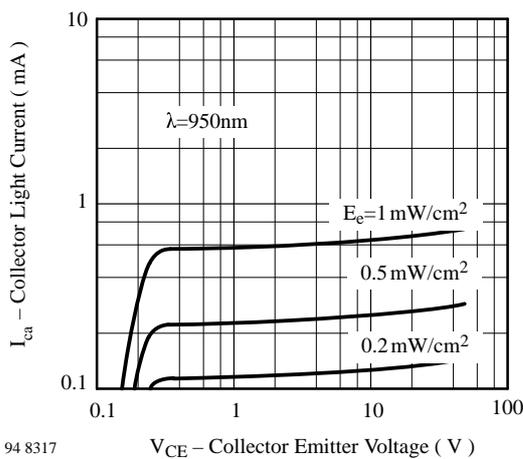


Figure 5. Collector Light Current vs. Collector Emitter Voltage

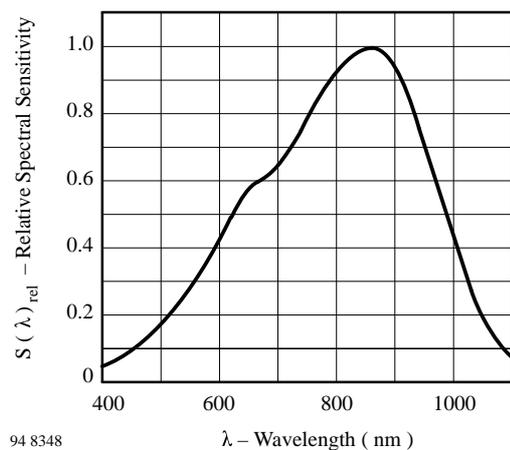
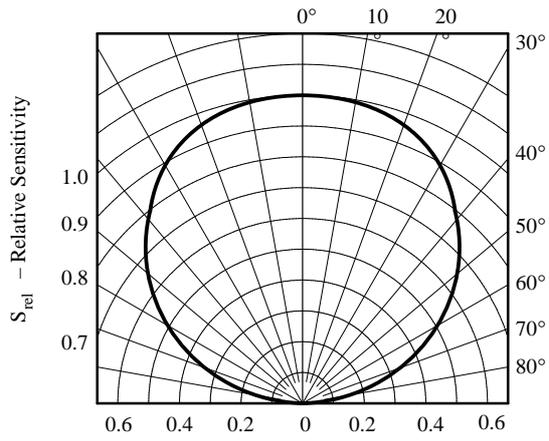


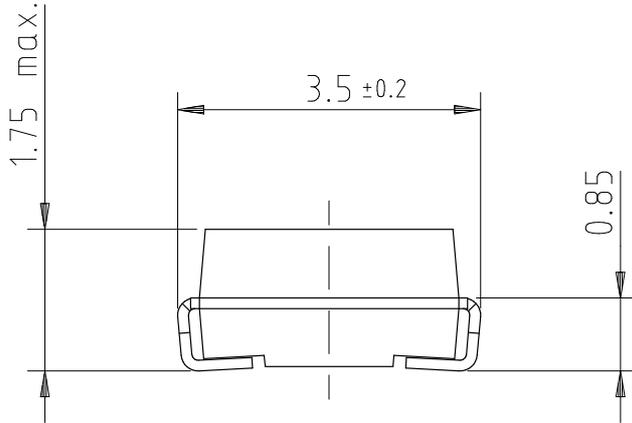
Figure 8. Relative Spectral Sensitivity vs. Wavelength



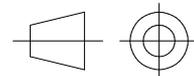
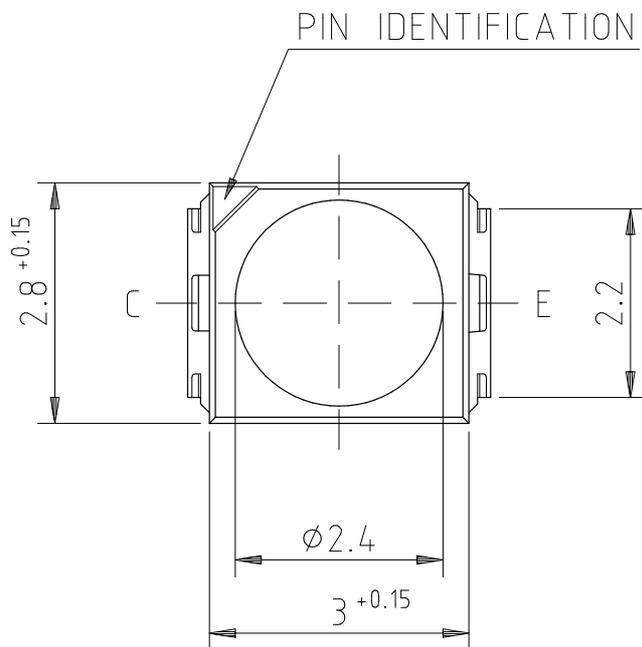
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Figure 9. Relative Radiant Sensitivity vs. Angular Displacement

Dimensions in mm



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technical drawings
according to DIN
specifications

Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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